

H7N0308AB

Silicon N Channel MOS FET
High Speed Power Switching

HITACHI

ADE-208-1569B(Z)

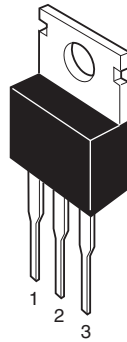
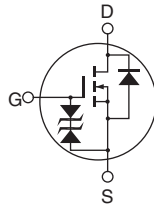
3rd. Edition
Aug. 2002

Features

- Low on-resistance
- $R_{DS(on)} = 3.8 \text{ m}\Omega$ typ.
- Low drive current
- 4.5 V gate drive device can be driven from 5 V source

Outline

TO-220AB



1. Gate
2. Drain (Fringe)
3. Source

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	30	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	70	A
Drain peak current	$I_{D(pulse)}$ ^{Note 1}	280	A
Body-drain diode reverse drain current	I_{DR}	70	A
Channel dissipation	Pch ^{Note 2}	100	W
Channel to Case Thermal Impedance	θ_{ch-c}	1.25	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	−55 to +150	°C

Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1 \%$
2. Value at Tc = 25°C

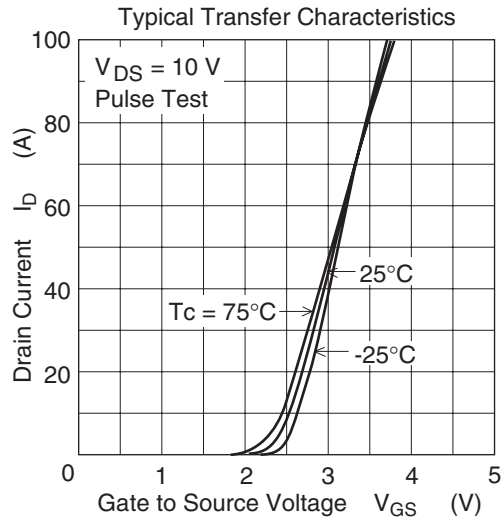
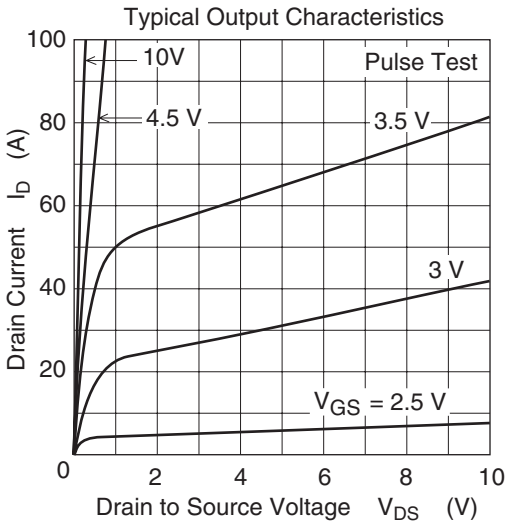
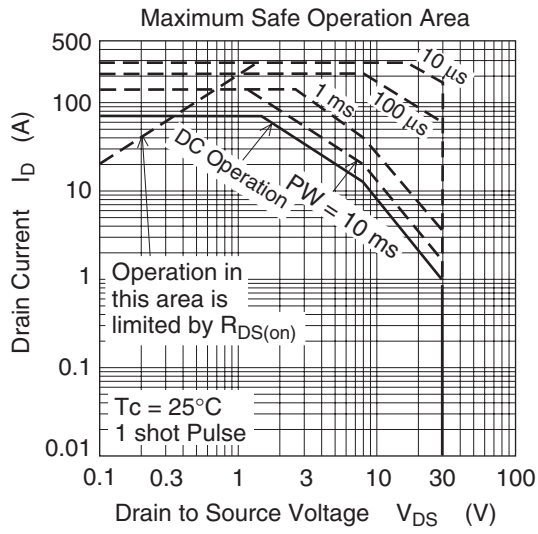
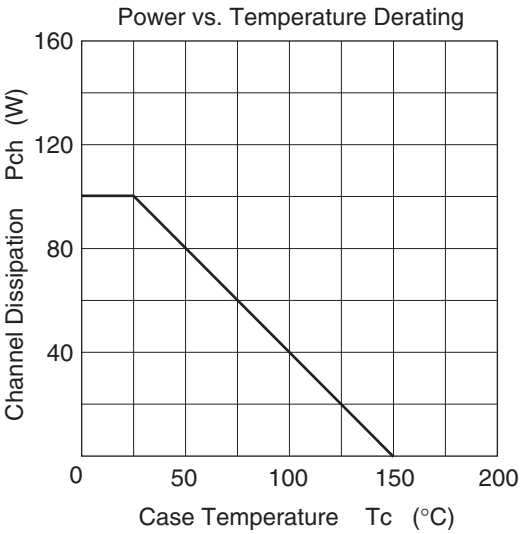
Electrical Characteristics

(Ta = 25°C)

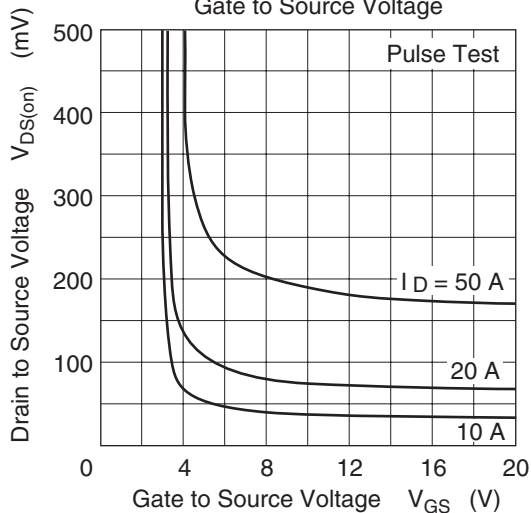
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 20	—	—		$I_G = \pm 100 \text{ }\mu\text{A}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 16 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	10	μA	$V_{DS} = 30 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.5	V	$I_D = 1 \text{ mA}$, $V_{DS} = 10 \text{ V}$ ^{Note 1}
Static drain to source on state resistance	$R_{DS(on)}$	—	3.8	4.8	m Ω	$I_D = 35 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{Note 1}
		—	6.0	8.5	m Ω	$I_D = 35 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ ^{Note 1}
Forward transfer admittance	$ y_{fs} $	54	90	—	S	$I_D = 35 \text{ A}$, $V_{DS} = 10 \text{ V}$ ^{Note 1}
Input capacitance	C_{iss}	—	3350	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	840	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	480	—	pF	$f = 1 \text{ MHz}$
Total gate charge	Q_g	—	52	—	nc	$V_{DD} = 10 \text{ V}$
Gate to source charge	Q_{gs}	—	11	—	nc	$V_{GS} = 10 \text{ V}$
Gate to drain charge	Q_{gd}	—	10	—	nc	$I_D = 70 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	30	—	ns	$V_{GS} = 10 \text{ V}$, $I_D = 35 \text{ A}$
Rise time	t_r	—	370	—	ns	$R_L = 0.29 \text{ }\Omega$
Turn-off delay time	$t_{d(off)}$	—	80	—	ns	$R_g = 4.7 \text{ }\Omega$
Fall time	t_f	—	27	—	ns	
Body-drain diode forward voltage	V_{DF}	—	0.93	—	V	$I_F = 70 \text{ A}$, $V_{GS} = 0$
Body-drain diode reverse recovery time	t_{rr}	—	60	—	ns	$I_F = 70 \text{ A}$, $V_{GS} = 0$ $di_F/dt = 50 \text{ A}/\mu\text{s}$

Notes: 1. Pulse test

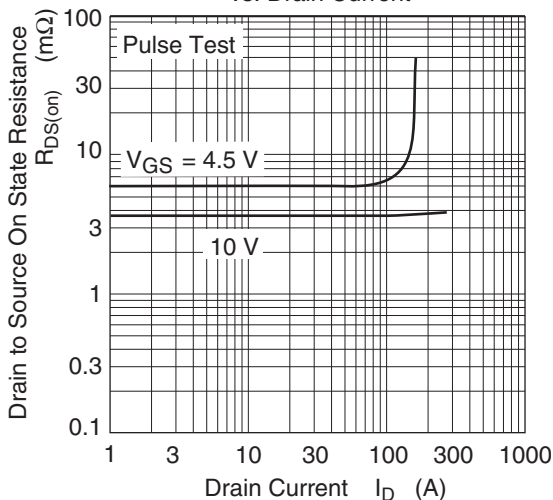
Main Characteristics



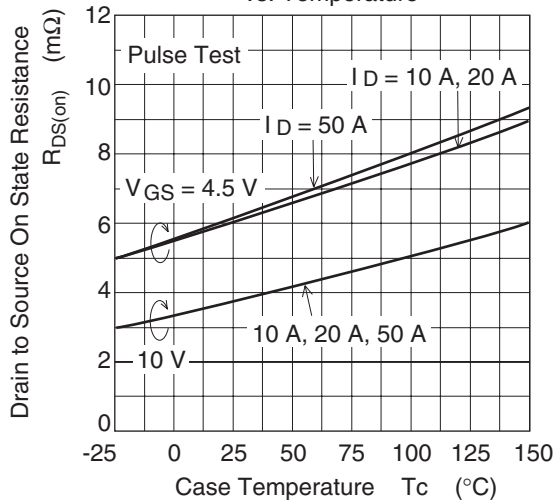
Drain to Source Saturation Voltage vs.
Gate to Source Voltage



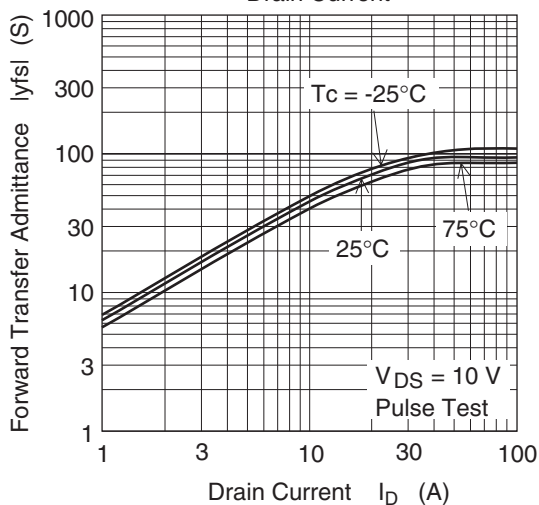
Static Drain to Source on State Resistance
vs. Drain Current

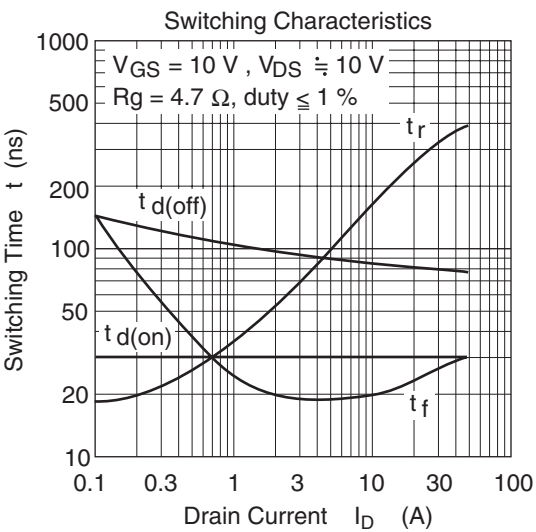
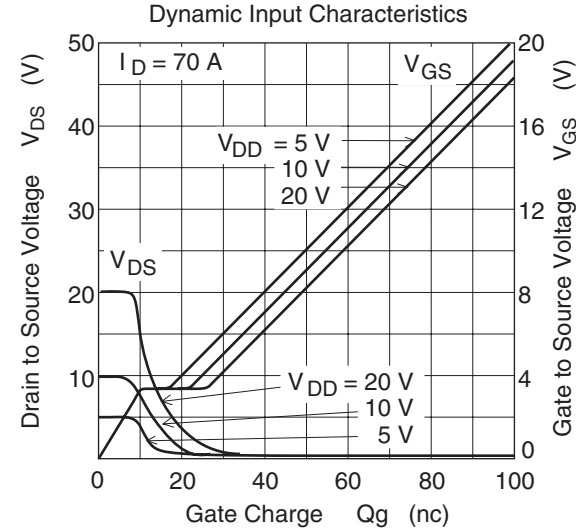
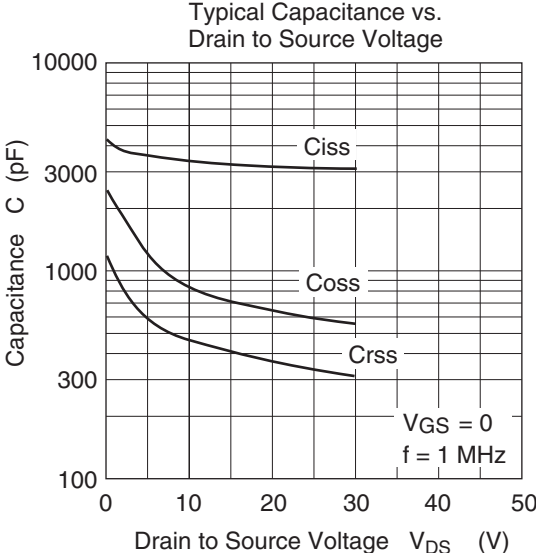
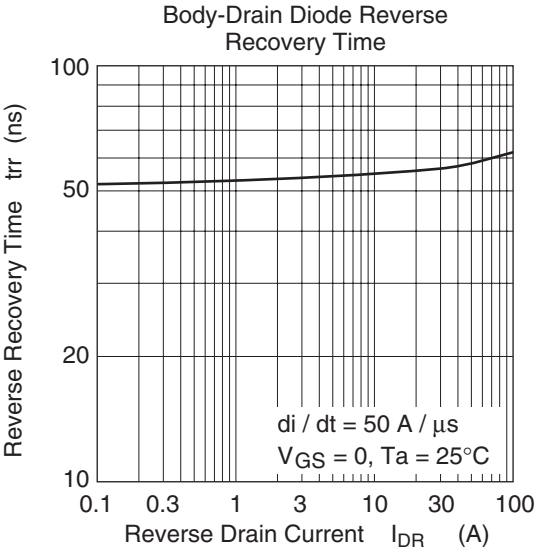


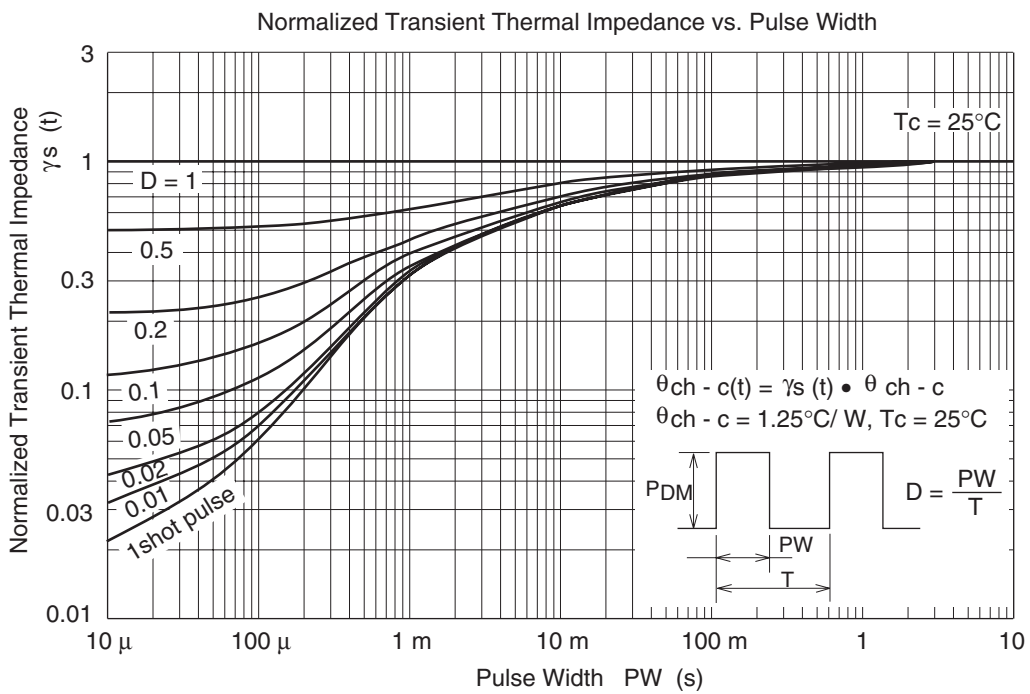
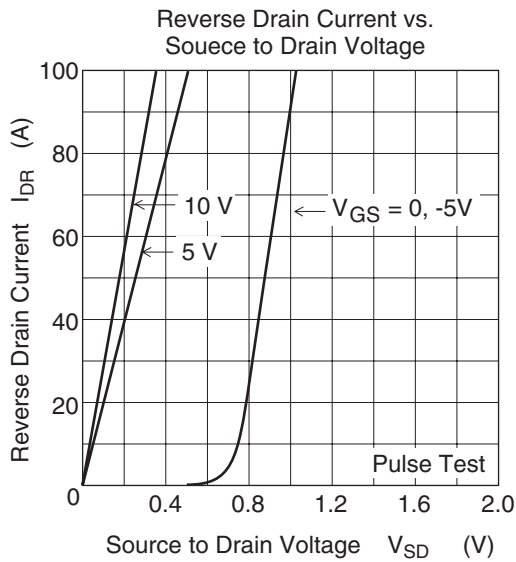
Static Drain to Source on State Resistance
vs. Temperature



Forward Transfer Admittance vs.
Drain Current

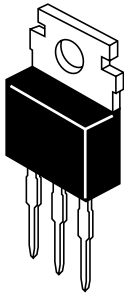
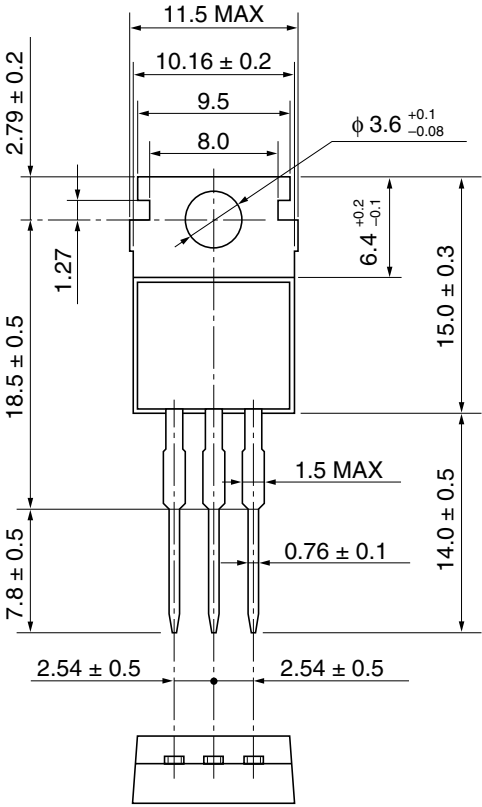






Package Dimensions

As of January, 2002
Unit: mm



Hitachi Code	TO-220AB
JEDEC	Conforms
JEITA	Conforms
Mass (reference value)	1.8 g

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